

## **Customer Information Notification**

Issue Date: 30-Jun-2019 Effective Date: 01-Jul-2019 Dear Emma Tempest,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP. For detailed information we invite you to <u>view this</u> notification online

### This notice is NXP Company Proprietary.

### 2019060231



# QUALITY

### **Management Summary**

Update PCA9575 Datahsheet for PCA9575HF / HWSON24 max temperature range and Table 22 IstbL and IstbH max limits.

#### **Change Category**

| enange eategery  |                             |                                |                        |  |
|--|-----------------------------|--------------------------------|------------------------|--|
| []Wafer Fab Process  | []<br>Assembly<br>Process   | [] Product Marking             | [] Test<br>Location    | [] Design                                |
| [] Wafer Fab Materials   | []<br>Assembly<br>Materials | [] Mechanical<br>Specification | []Test<br>Process      | [] Errata                                |
| [] Wafer Fab Location  | []<br>Assembly<br>Location  | []<br>Packing/Shipping/Labelin | [] Test<br>g Equipment | [X] Electrical<br>spec./Test<br>coverage |
| [] Firmware  |                             | Data Sheet update              |                        | cereiage                                 |
| PCA9575HF HWQFN24<br>Datasheet Max Temp<br>Change & Table 22 (Static<br>Characteristics) Istbl & Istbh<br>Max Current Change |                             |                                |                        |  |

### Description

PCA9575 datasheet (Rev 4.3 - 11-June 2019) updated as follows, for PCA9575HF / HWSON24:

- Temperature range updated from (-40C to +85C) to (-40C to +105C)

- Table 22 (Static characteristics) IstbL and IstbH max changed from 2ua to 3ua

Reason

PCA9575HF / HWQFN24 change to increase Tamb from +85C to +105C to cover additional usage cases. **Identification of Affected Products** 

Product identification does not change

| Anticipated Impact on Form, Fit, Function, Reliability or Quality  |  |  |  |  |
|--|--|--|--|--|
| No impact on form, fit, function, reliability or quality.  |  |  |  |  |
| Data Sheet Revision  |  |  |  |  |
| A new datasheet will be issued   |  |  |  |  |
| Disposition of Old Products  |  |  |  |  |
| Existing inventory will be shipped until depleted  |  |  |  |  |
| Additional information   |  |  |  |  |
| Affected products and sales history information: see attached file<br>Additional documents: <u>view online</u>                           |  |  |  |  |
| Contact and Support  |  |  |  |  |
| For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality</u> <u>Support Team"</u> . |  |  |  |  |
| For all Quality Notification content inquiries, please contact your local NXP Sales Support team.  |  |  |  |  |

For specific questions on this notice or the products affected please contact our specialist directly:NameEmilio PoloPositionQuality Reliability Engineer

e-mail address emilio.polo@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team. About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

| View Notification | Subscription | <u>Support</u> |
|-------------------|--------------|----------------|
|                   |              |                |

NXP | Privacy Policy | Terms of Use

NXP Semiconductors

High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.